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STF5N65M6

N-channel 650 V, 1.15 Ω typ., 4 A MDmesh[™] M6 Power MOSFET in a TO-220FP package

Datasheet - production data

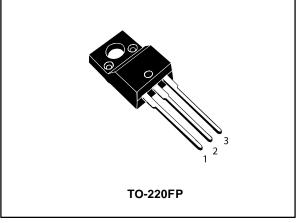
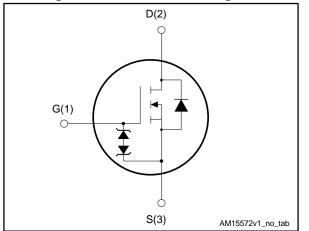


Figure 1: Internal schematic diagram



Features

Order code	VDS	R _{DS(on)} max.	ID
STF5N65M6	650 V	1.3 Ω	4 A

- Reduced switching losses
- Lower R_{DS(on)} x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

The new MDmesh[™] M6 technology incorporates the most recent advancements to the well-known and consolidated MDmesh family of SJ MOSFETs. STMicroelectronics builds on the previous generation of MDmesh devices through its new M6 technology, which combines excellent R_{DS(on)} * area improvement with one of the most effective switching behaviors available, as well as a user-friendly experience for maximum endapplication efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing	
STF5N65M6	5N65M6	TO-220FP	Tube	

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	± 25	V
ID	Drain current (continuous) at T _C = 25 °C	4	А
ID	Drain current (continuous) at Tc = 100 °C	2.5	А
Idм ⁽¹⁾	Drain current (pulsed)	16	А
P _{TOT}	Total dissipation at $T_C = 25 \ ^{\circ}C$	20	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	5	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	v/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s, T_C = 25 °C)	2.5	kV
TJ	Operating junction temperature range	EE to 150	.0°
T _{stg}	Storage temperature range	-55 to 150	C

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by safe operating area

 $^{(2)}I_{SD} \leq$ 4 A, di/dt = 400 A/µs; V_{DS peak} < V(BR)DSS, V_{DD} = 400 V $^{(3)}V_{DS} \leq$ 520 V

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R _{thj} -case	Thermal resistance junction-case	6.25	°C ///	
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W	

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax})	1	А
E _{as}	Single pulse avalanche energy (starting $T_j=25^{\circ}C$, $I_D=I_{AR}$, $V_{DD}=50$ V)	90	mJ



2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

Table 5: On/off-state							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
V _{(BR)DSS}	Drain-source breakdown voltage	V _{GS} = 0, I _D = 1 mA	650			V	
		$V_{GS} = 0 V, V_{DS} = 650 V$			1	μA	
I _{DSS} Zero gate voltage of	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V};$ $T_{C} = 125 \text{ °C} (1)$			100	μA	
lgss	Gate body leakage current	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			±5	μA	
VGS(th)	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2.25	3	3.75	V	
R _{DS(on)}	Static drain-source on-resistance	$V_{GS}=10~V,~I_{D}=2~A$		1.15	1.3	Ω	

Table 5: On/off-state

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	170	-	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	-	20	-	pF
C _{rss}	Reverse transfer capacitance	VDS = 100 V, I = I MHZ, VGS = 0 V		1	-	pF
C _{oss} eq. ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 520 V, V_{GS} = 0 V	-	35	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D =0 A	-	5	-	Ω
Qg	Total gate charge	Vpp = 350 V, lp = 1 A, Vgs= 10 V,	-	5.1	-	nC
Q_{gs}	Gate-source charge	(see Figure 15: "Test circuit for	-	0.8	-	nC
Q_{gd}	Gate-drain charge	gate charge behavior")	-	2	-	nC

Table 6: Dynamic

Notes:

 $^{(1)}C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table	7:	Switching	times
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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 325 V, I_D = 2 A, R_G = 4.7 Ω ,	-	6.5	-	ns
tr	Rise time	V _{GS} = 10 V (see Figure 14: "Test circuit for resistive load switching		5.9	-	ns
t _{d(off)}	Turn-off delay time	times" and Figure 19: "Switching	-	17.4	-	ns
tr	Fall time	time waveform")	-	15.2	-	ns

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Electrical characteristics

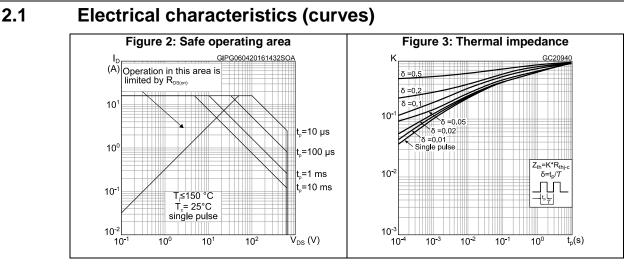
	Table 8: Source-drain diode							
Symbol	mbol Parameter Test conditions				Max.	Unit		
Isd	Source-drain current		-		4	А		
Isdm ⁽¹⁾	Source-drain current (pulsed)		-		16	А		
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 4 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-		1.6	V		
trr	Reverse recovery time	I _{SD} = 4 A, di/dt = 100 A/µs,	-	222		ns		
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}$, (see <i>Figure 19</i> :		1.24		μC		
Irrm	Reverse recovery current	"Switching time waveform")	-	11.2		А		
trr	Reverse recovery time	I _{SD} = 4 A, di/dt = 100 A/µs,	-	264		ns		
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 19: "Switching	-	1.39		μC		
I _{RRM}	Reverse recovery current	time waveform")	-	10.5		А		

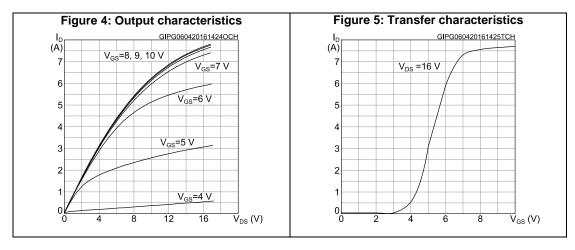
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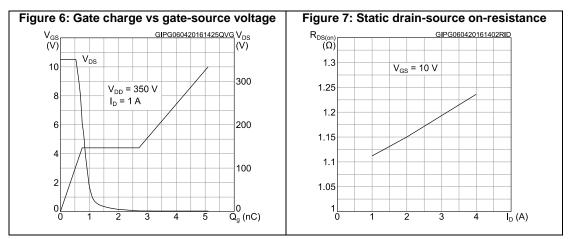
⁽¹⁾Pulse width limited by safe operating area

 $^{(2)}\text{Pulsed:}$ pulse duration = 300 µs, duty cycle 1.5%







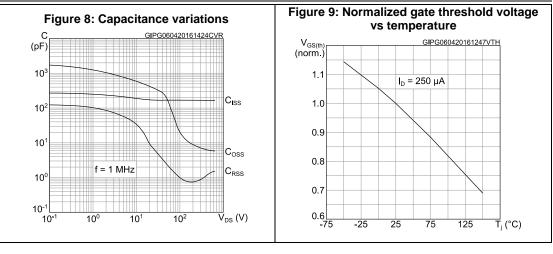


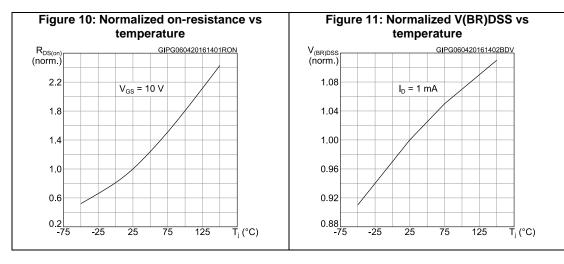
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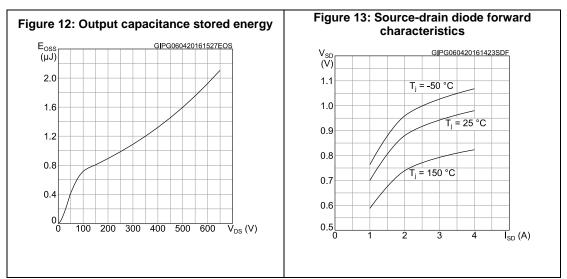
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Electrical characteristics



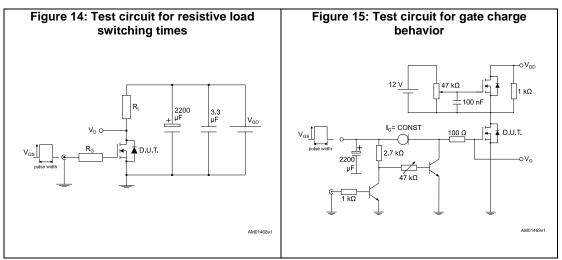


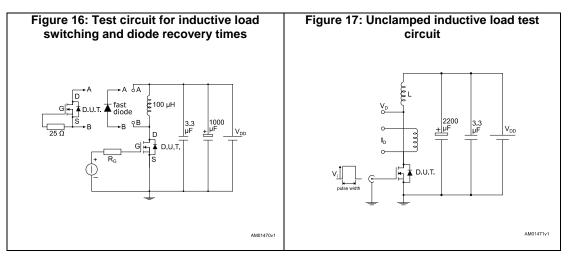


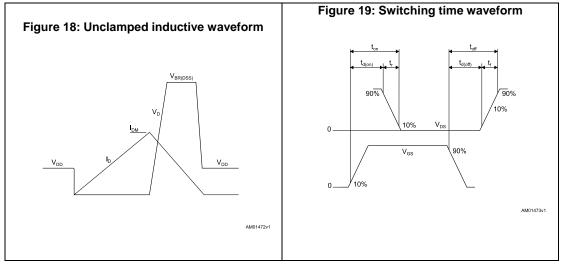
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3 Test circuits







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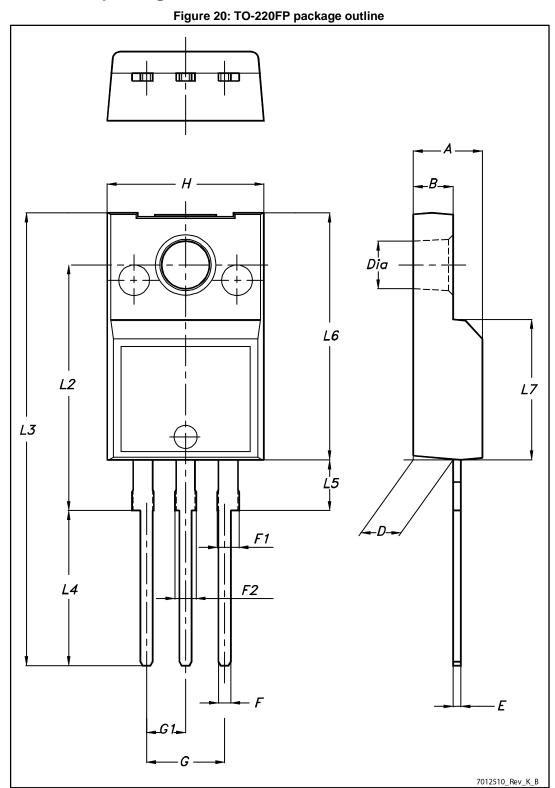


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.







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Package information

M6			Package information
	Table 9: TO-220FP page	ckage mechanical dat	a
Dim		mm	
Dim.	Min.	Тур.	Max.
A	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2



5 Revision history

Table 10: Document revision history

Date	Revision	Changes
05-May-2016	1	Initial release.



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